RENESAS

QCIOT4-DA16600POCZ

Combo Wireless PMOD™ Module Evaluation Board

The QCIOT4-DA16600POCZ is a combo wireless PMOD[™] module having Wi-Fi and Bluetooth[®] Low Energy (BLE) connectivity. The QC-IOT4 PMOD module is designed based on highly integrated ultralow-power Wi-Fi + Bluetooth Low Energy using a DA16600 combo module solution. Two PMOD connectors are available for Wi-Fi and BLE communication with SPI and UART interfaces, respectively. All of the PMOD signals are also made available when the QC-IOT4 module is interfaced with an Arduino shield connector.

Board Contents

QCIOT4-DA16600POCZ Evaluation Board

Features

- Support both RTOS and Linux operating systems:
 - Linux: SPI→Wi-Fi, UART→BLE
 - RTOS (optional): SPI→Wi-Fi/BLE, UART→Wi-Fi/BLE Low power single-band Wi-Fi and BLE communication
- Low power single-band Wi-Fi and BLE
- 3.3V power operated
- 4-layer PCB
- Applications include (but not limited to) IIoT, Gateways
- Standardized type 2A/3A PMOD[™] connector supports SPI/UART extended interface
- Standard Arduino connector supports SPI and UART
- Dual connectors allow pass-through signals for daisy-chained solutions in RTOS system mode

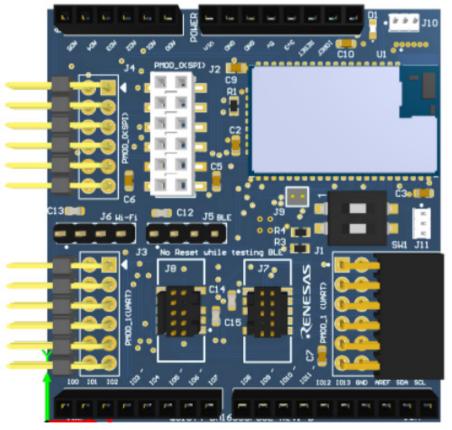


Figure 1. QCIOT4-DA16600POCZ PMOD Evaluation Board (top)



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1. Functional Description

The QC-IOT4 PMOD is a Wi-Fi/BLE-enabled module for any SPI/UART MPU/MCUs. The module can connect to an MCU board through Arduino shield or to an RZ family/MPU carrier board through PMOD. The QC-IOT4 uses the DA16600MOD Wi-Fi/BLE module, providing ultra-low power Wi-Fi IEEE802.11b/g/n, 1×1, 20MHz channel bandwidth 2.4GHz, and Bluetooth v5.1.

2. Setup

2.1 Required Equipment

The following additional lab equipment (sold separately) is required for using the board:

- Any MPU board that supports both Type 2A and 3A PMOD
- Any MCU board that supports Arduino connection (see Table 1)

Table 1. Renesas MPU and MCU Evaluation Kits Capable of Supporting Type 2A/3A PMOD/Arduino Connector Using the QCIOT4-DA16600POCZ

| RZ | RA | RL78 |
|------------|-----------|--------------|
| EK-RZ/G2L | EK-RA4W1 | RL78/G23-FPB |
| EK-RZ/V2L | EK-RA2A1 | RL78/G22-FPB |
| EK-RZ/G2UL | EK-RA4M1 | RL78/G14-FPB |
| EK-RZ/A3UL | EK-RA6M1 | RL78/G15-FPB |
| EK-RZ/Five | EK-RA6M2 | - |
| - | EK-RA6M3 | - |
| - | EK-RA6M3G | - |

Note: The table above is not a comprehensive list of supporting MPU and MCU Kits. See the respective evaluation kit hardware manual to confirm PMOD/Arduino pinout.

2.2 Software Tools and Versions

2.2.1 MPU Platform

- 1. For Host details and RZ BSP versions, refer to the Operating Environment section in the software manual.
- 2. Port the DA16600 Linux driver to RZ/G2L Kernel 5.10 latest BSP.
- 3. Add the Linux driver to the RZ family BSP to support all RZ devices (RZ/G2L tested only).
- 4. Connect to the board following the hardware connection section (see Figure 2).
- 5. Visit Renesas <u>Quick-Connect IoT Platform</u> for more information about creating your customized system solution.

Important: Do not use the reset button (blue button) while BLE testing.

Note: The RZ/G2L is currently the only solution available. Other MPU software is in development.

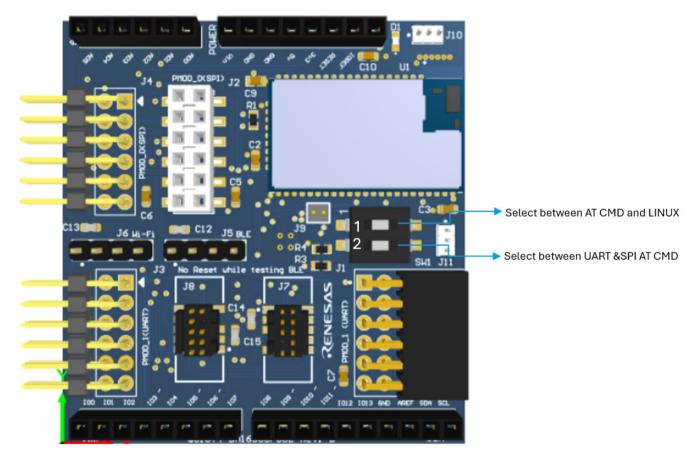
2.2.2 MCU Platform

- 1. Download AT CMD binary from the webpage.
- 2. Flash the binary to the QC-IOT4 board.
- 3. Reflash MCU software.
- 4. Connect the QC-IOT4 board to the MCU board (see Figure 3).

Note: Refer to the "QC-IOT4 DA16600 AT-CMD Test Manual" for detailed descriptions of how to flash:

- AT-CMD (SPI and UART) binary in DA16600
- Firmware in RA6M4 MCU for AT-CMD test

2.3 On-board Switches



| Table 2. Truth Table for On-board Switches | Table 2. | Truth Table | for On-board | Switches |
|--|----------|-------------|--------------|----------|
|--|----------|-------------|--------------|----------|

| SW1 | SW2 | Function |
|-----|-----|-------------|
| 0 | 0 | UART AT CMD |
| 0 | 1 | SPI AT CMD |
| 1 | x | Linux |

Note: The "ON" label written on the switch means that the switch is closed and the line is pulled to ground. GP will read it as a logic 0 or Low. Vice versa for the other switch positions.

2.4 Evaluation Kit Hardware Connections

2.4.1 MPU Platform

Use the following procedures to set up the kit connections with RZ/G2L SMARC EVK as shown in Figure 2.

- 1. Connect QCIOT4-DA16600POCZ module to PMOD connector of RZ/G2L SMARC EVK platform.
- 2. Connect the micro-SD Card to the slot present in the carrier board connection (see Figure 2).
- 3. Connect debug console to the serial terminal application software (see Figure 2)
- 4. Wi-Fi router that connects wirelessly to QCIOT4-DA16600POCZ module.
- 5. Wi-Fi router that connects wired/wireless to desktop/laptop.
- 6. Before powering up the board, check the switch settings on the QCIOT4-DA16600POCZ board. For Linux, SW1 should be 1, irrespective of the position of SW2 (for detailed information, see section 3.3).
- 7. Power on SMARC EVK using a type C USB cable.

Important: No other Arduino shield on the top of QCIOT4-DA16600POCZ board is recommended.

Note: PMOD female connectors are redundant (not available for use).

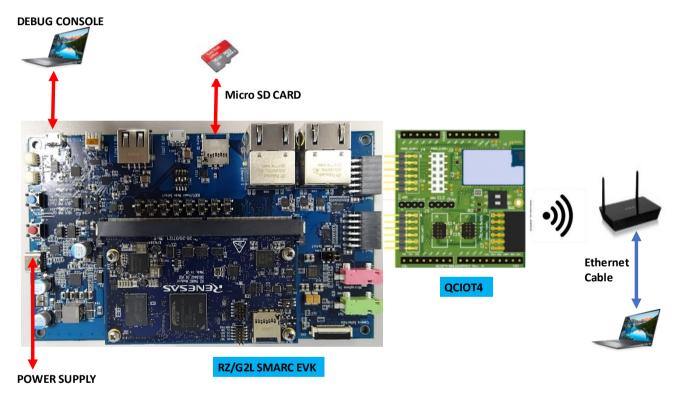


Figure 2. Evaluation Kit Connections with RZ/G2L

2.4.2 MCU Platform

Use the following procedures to set up the kit connections with RA6M4 EVK as shown in Figure 3.

- 1. The QCIOT4-DA16600POCZ board can be interfaced with RA6M4 MCU EVK with Arduino connector provision.
- 2. Connect the QCIOT4-DA16600POCZ board with MCU as shown in Figure 3.
- 3. Before powering up the board check the switch settings on QCIOT4-DA16600POCZ board (for detailed information, see section 3.3).
- 4. Connect the USB debug port of RA6M4 to the PC as shown in Figure 3.

Important: No other Arduino shield on the top of QCIOT4-DA16600POCZ board is recommended.

Note: If SPI is in use for Wi-Fi/BLE communication, the UART PMOD (PMOD1) is available, and vice versa.

Note: Jumper option J10 is available to switch between Wi-Fi and BLE (without jumper the kit is in Wi-Fi mode; with jumper it is in BLE mode). Then using the serial interface, select the channels for Wi-Fi (IO0 and IO1 of Arduino connector) and BLE (pin 1 of J3 and J1).

Note: Jumper option J11 is available for BLE reset which is required while flashing the BLE firmware to the board using the Renesas <u>SmartBond™ Development Tools</u>.

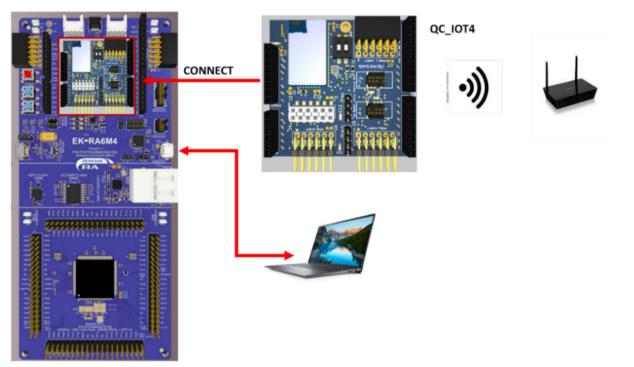


Figure 3. Evaluation Kit Connections with RA6M4 EVK

2.4.3 Standalone Wi-Fi or BLE Mode for RF Test Setup

Use the following procedures to setup the kit connections that enable the standalone QC-IOT4 board to work either in Wi-Fi or BLE mode.

Wi-Fi Mode

- 1. By default, the device is in Wi-Fi Mode without jumper on J10.
- 2. Select the wi-fi channel using serial.
- 3. With the USB to Serial converter, use pins IO0 and IO1 of the Arduino connector to assess the serial.
- 4. Channel selection can now be performed using the DA16200_DA16600_AT_GUI Tool.

BLE Mode

- 1. Short the jumper on J10 to place the device in BLE mode.
- 2. Download the firmware for BLE (GUI ask for BLE Reset). This is accomplished by shorting the jumper setting J11 for 1 to 2 seconds.
- 3. Using the USB to Serial converter, connect Pin_1 of J1 and J3. Then using the <u>SmartBond™ Development</u> <u>Tools</u>, perform channel selection for BLE.

Note: The entirety of the above procedures are performed only when compliance testing is required.

3. Application Schematic

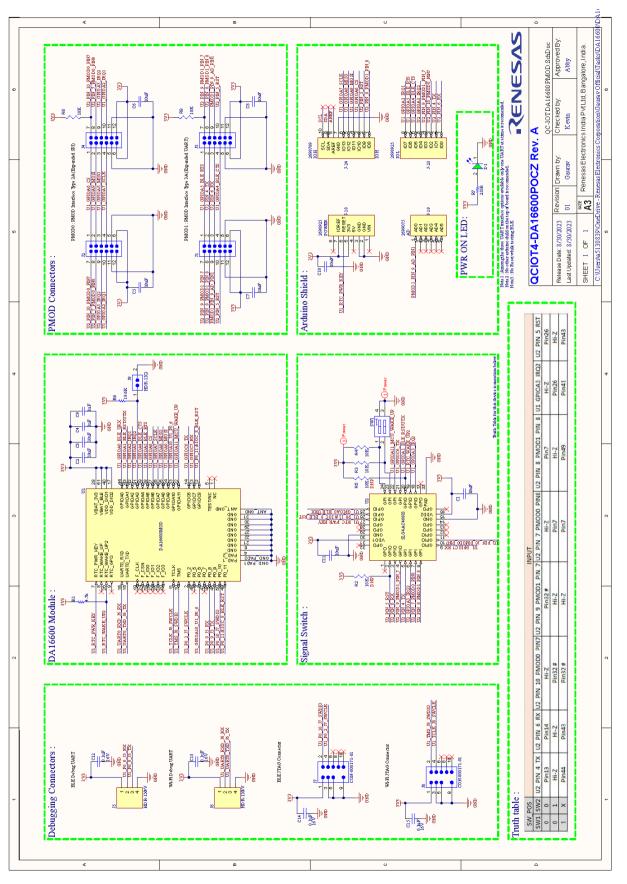


Figure 4. QCIOT4-DA16600POCZ Application Schematic

4. Bill-of-Materials (BOM)

| ltem | Qty | Reference | Description | Value | PCB Footprint | Part Number |
|------|-----|--|---|-----------|--------------------------|----------------------------|
| 1 | 1 | AD | 6 Position Receptacle Connector 0.100" (2.54mm) Through Hole Gold | - | TH (P-2.54mm) | SSQ-106-03-G-S |
| 2 | 9 | C1, C2, C3, C5, C6, C7, C8, C10, C11 | 10μF ±10% 16V Ceramic Capacitor X5R 0603 (1608 Metric) | 10µF | 0603 | 885012106031 |
| 3 | 2 | C4, C9 | Chip Capacitor, 1µF, ±10%, 16V, 0603 (1608 Metric) | 1µF | 0603 | 885012206052 |
| 4 | 4 | C12, C13, C14, C15 | 0.1µF ±10% 16V Ceramic Capacitor X7R 0603 (1608 Metric) | 0.1µF | 0603 | 885012206046 |
| 5 | 1 | D1 | WL-SMCD Mono-color Chip LED Diffused, SMT, size 0603, Bright Green, 2V, 140° | - | 0603 | 150060VS55040 |
| 6 | 1 | IOH | 10 Position Receptacle Connector 0.100" (2.54mm) Through Hole Gold | - | TH (P-2.54mm) | SSQ-110-03-G-S |
| 7 | 2 | IOL, Power | 8 Position Receptacle Connector 0.100" (2.54mm) Through Hole Gold | - | TH (P-2.54mm) | SSQ-108-03-G-S |
| 8 | 1 | J1 | 12 Position Receptacle Connector 0.100" (2.54mm) Through Hole, Right Angle Gold | - | TH (P-2.54 × 2.54mm) | 613012243121 |
| 9 | 1 | J2 | CONN Socket 12POS 2ROW Vertical SMT | - | SMD (P-2.54 × 2.54mm) | 61001221821 |
| 10 | 2 | J3, J4 | Connector Header Through Hole, Right Angle 12-Position 0.100" (2.54mm) | - | TH (P-2.54 × 2.54mm) | 61301221021 |
| 11 | 2 | J5, J6 | Header, 1 × 4, 0.1" | - | TH (P-2.54mm) | 61300411121 |
| 12 | 2 | J7, J8 | 10-Position Shrouded Header 1.27mm Pitch Pin #7 Removed | - | SMD (P-1.27 × 1.27mm) | FTSH-105-01-L- DV-007-K |
| 13 | 1 | Jð | CONN Header VERT 2POS 1.27mm | - | TH (P- 1.27mm) | FTS-102-01-L-S |
| 14 | 2 | J10, J11 | Male Header, Pitch 1.27mm, 1 position, Height 4mm, Tail Length 2.3mm, -40 to 105°, RoHS, Bulk | - | TH (P-1.27mm) | GRPB031VWVNRC |
| 15 | 1 | R1 | Chip Resistor, 4.7kOhms, ±1%, 0.1 W, -55 to 155 °C, 0603 (1608 Metric) | 4.7kOhm | 0603 | RC0603FR-134K7L |
| 16 | 0 | R2, R5, R8, R9 | Chip Resistor, 10kOhms, ±1%, 01 W, -55 to 155 °C, 0603 (1608 Metric) | 10kOhm | 0603 | RC0603FR-0710KL |
| 17 | 2 | R3, R4 | Chip Resistor, 10kOhms, ±1%, 01 W, -55 to 155 °C, 0603 (1608 Metric) | 10kOhm | 0603 | RC0603FR-0710KL |
| 18 | 1 | R6 | 19.6kOhms ±1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric) | 19.6kOhms | 0603 | RC0603FR- 0719K6L |

Table 3. QC-IOT4 Evaluation Board Bill-of-Materials

QCIOT4-DA16600POCZ Evaluation Board Manual

| Item | Qty | Reference | Description | Value | PCB Footprint | Part Number |
|------|-----|--------------|---|----------|-------------------------------|-------------------------|
| 19 | 1 | R7 | 255 Ohms ±1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric) Moisture Resistant Thick Film | 255 Ohms | 0603 | RC0603FR- 07255RL |
| 20 | 1 | SW1 | DIP Switch, 2-Position, SPST | - | 2.54 × 6.02 × 4.40 (PxLxH) | 418121270802 |
| 21 | 1 | U1 | DA16600MOD, Wi-Fi, 802.11b/g/n, Bluetooth LE, Combo Module, SM | - | 14.3 × 24.3 × 3.0 | DA16600MOD- AAC4WA32 |
| 22 | 1 | U2 | GreenPAK Programmable Mixed-signal Matrix with Asynchronous State Machine and Dual Supply | - | TQFN-32 | SLG4AC46683 |
| 23 | 3 | Short Jumper | 2 (1 × 2) Position Shunt Connector Black Closed Top, Grip 0.050" (1.27mm) Gold | - | - | M50-2000005 |

5. Board Layout

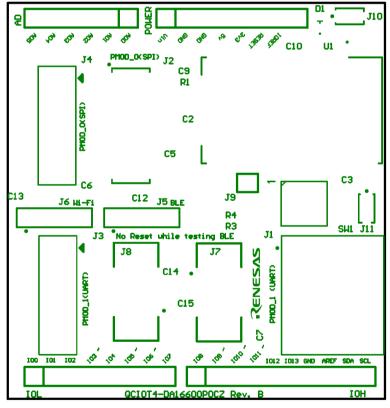


Figure 5. Silkscreen Top

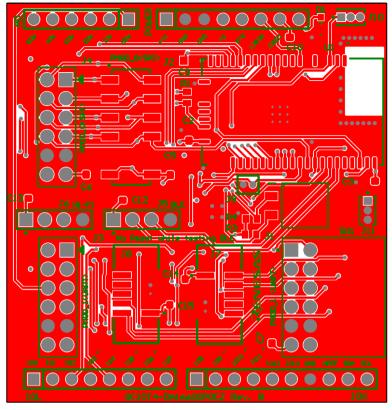


Figure 6. Copper Top

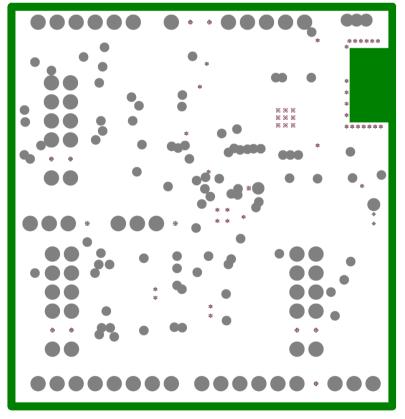


Figure 7. Copper L1 Plane (GND)

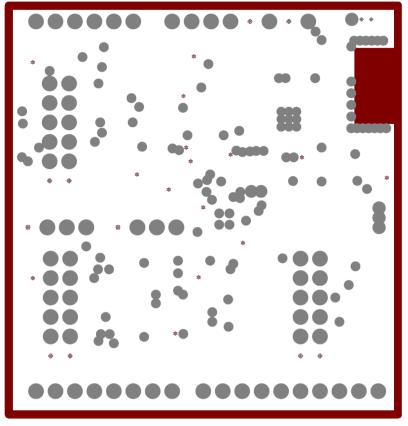


Figure 8. Copper L2 Plane (PWR)

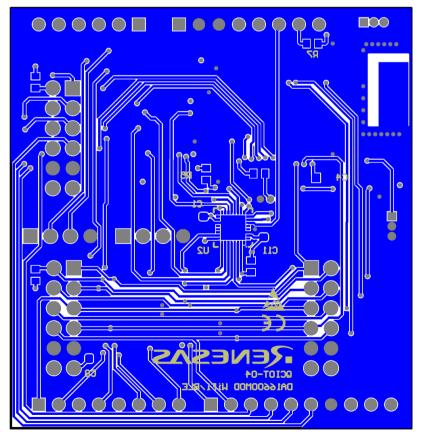


Figure 9. Copper Bottom



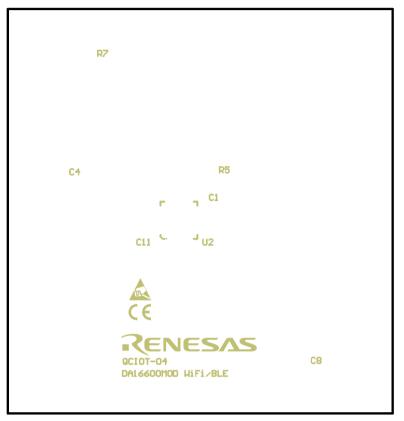


Figure 10. Silkscreen Bottom

6. Ordering Information

| Part Number | Description | | |
|--------------------|--|--|--|
| QCIOT4-DA16600POCZ | QCIOT04-DA16600POCZ PMOD™ Evaluation Board | | |

7. Revision History

| Revision | Date | Description |
|----------|--------------|--|
| 1.01 | Sep 6, 2024 | Updated Figure 1, Figure 5, Figure 6, Figure 7, Figure 8, Figure 9, and Figure 10. Updated items 7 and 14 and added item 23 in Table 3. Updated image in section 2.3. Added notes to section 2.4.2. Added section 2.4.3. |
| 1.00 | Sep 13, 2023 | Initial release. |

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